Surface Mount - 50V





Additional Information







Accessories



Samples

Description

MAC8SxG is designed for industrial and consumer applications for full wave control of ac loads such as appliance controls, heater controls, motor controls, and other power switching applications.

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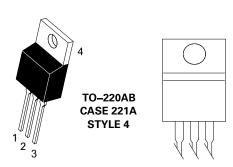
- **Features**
- Sensitive Gate Allows Triggering by Microcontrollers and other Logic Circuits
- Uniform Gate Trigger Currents in Three Quadrants; Q1, Q2, and Q3
- High Immunity to dv/dt 25 V/µs Minimum at 110°C
- High Commutating di/dt 8.0 A/ms Minimum at 110°C
- Maximum Values of I_{GT}, V_{GT} and I_H Specified for Ease of Design

- On-State Current Rating of 8 Amperes RMS at 70°C
- High Surge Current Capability - 70 Amperes
- Blocking Voltage to 800 Volts
- Rugged, Economical TO-220 Package
- These Devices are Pb-Free and are RoHS Compliant

Functional Diagram



Pin Out





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Maximum Ratings (TJ = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit	
Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, $T_J = 25^{\circ}$ to 110°C)	MAC8SDG MAC8SMG MAC8SNG	V _{DRM} , V _{RRM}	400 600 800	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, $T_c = 7$	0°C)	I _{T (RMS)}	8.0	Α
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T,= 110°C)		I _{TSM}	70	А
Circuit Fusing Consideration (t = 8.3 ms)		l²t	20	A²sec
Peak Gate Power (Pulse Width $\leq 1.0 \mu s$, $T_c = 70^{\circ}C$)		P _{GM}	16	W
Average Gate Power (t = 8.3 ms, $T_c = 70^{\circ}$ C)		$P_{G(AV)}$	0.35	W
Operating Junction Temperature Range		T _J	-40 to +110	°C
Storage Temperature Range		T _{stg}	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Thermal Characteristics

Rating		Symbol	Value	Unit
Thermal Resistance,	Junction-to-Case (AC) Junction-to-Ambient	R _{eJC} R _{eJA}	2.2 62.5	°C/W
Maximum Lead Temperature for Soldering Purpose: 10 seconds	s, 1/8" from case for	T_L	260	°C

Electrical Characteristics - OFF (TJ = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current	T_ = 25°C	I _{DRM} ,	-	-	0.01	m Λ
$(V_D = V_{DRM} = V_{RRM}; Gate Open)$	$T_{J}^{\circ} = 110^{\circ}C$	I	-	-	2.0	mA

Electrical Characteristics - ON (TJ = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak On-State Voltage (Note 4) ($I_{TM} = \pm 11 \text{ A}$)		V_{TM}	_	-	1.85	V
Gate Trigger Current	MT2(+), G(+)		_	2.0	5.0	
(Continuous dc)	MT2(+), G(-)	I _{GT}	_	3.0	5.0	mA
$(V_{D} = 12 \text{ V}, R_{L} = 100 \Omega)$	MT2(-), G(-)		_	3.0	5.0	
Holding Current ($V_D = 12 \text{ V}$, Gate Open, Initiating Current = ± 1	50 mA))	I _H	-	3.0	10	mA
	MT2(+), G(+)		_	5.0	15	
Latching Current $(V_D = 24 \text{ V}, I_G = 5 \text{ mA})$	MT2(+), G(-)	IL	_	10	20	mA
(V _D = 24 V, I _G = 3 111 V)	MT2(-), G(-)		_	5.0	15	
0 . 7:	MT2(+), G(+)		0.45	0.62	1.5	
Gate Trigger Voltage $(V_D = 12 \text{ V}, R_I = 100 \Omega)$	MT2(+), G(-)	$V_{\rm GT}$	0.45	0.60	1.5	V
(V _D = 12 V, H _L = 100 22/	MT2(-), G(-)		0.45	0.65	1.5	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Indicates Pulse Test: Pulse Width ≤ 2.0 ms, Duty Cycle ≤ 2%



^{1.} V_{DBM} and V_{BBM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

MAC8SDG, MAC8SMG, MAC8SNG Surface Mount – 50V



Dynamic Characteristics

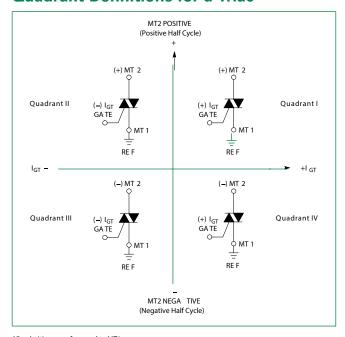
Characteristic	Symbol	Min	Тур	Max	Unit
Rate of Change of Commutating Current See Figure 10. ($V_D = 400 \text{ V}$, $I_{TM} = 3.5 \text{ A}$, Commutating dv/dt = 10 V/ μ s, Gate Open, $T_J = 110^{\circ}\text{C}$, f = 500 Hz, Snubber), $C_S = 0.01 \mu\text{F}$, $R_S = 15 \Omega$	di/dt _(C)	8.0	10	_	A/ms
Critical Rate of Rise of Off-State Voltage ($V_D = Rated V_{DRM}$, Exponential Waveform, $R_{GK} = 510 \Omega$, $T_J = 110^{\circ}$ C)	dV/dt	25	75	_	V/µs

Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
$V_{_{\mathrm{RRM}}}$	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V_{TM}	Maximum On State Voltage
I _H	Holding Current

On stat e V_{TM} Quadrant 1 Main Terminal 2 + V_{TM} V_{TM} V_{TM} Off stat e V_{DRM} Quadrant 3 Main Terminal 2 V_{TM} V_{TM} Off stat e V_{DRM} V_{DRM} V_{DRM}

Quadrant Definitions for a Triac



All polarities are referenced to MT1. With in—phase signals (using standard AC lines) quadrants I and III are used

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Figure 1. RMS Current Derating

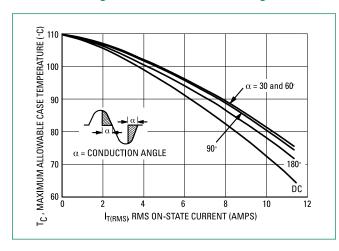


Figure 3. On-State Characteristics

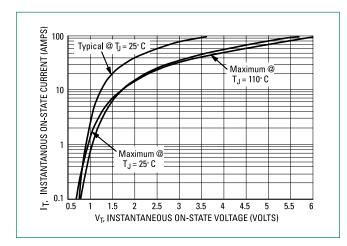


Figure 5. Typical Holding Current Vs. Junction Temperature

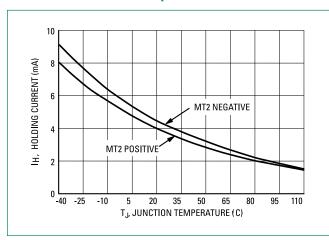


Figure 2. Maximum On-State Power Dissipation

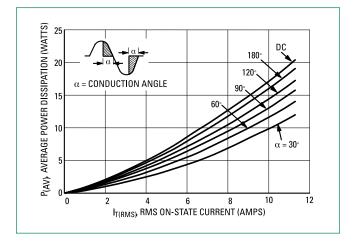


Figure 4.Transient Thermal Response

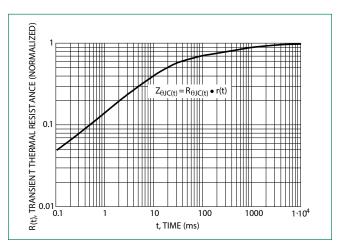
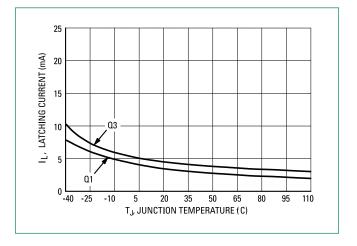


Figure 6. Typical Latching Current Vs. Junction Temperature





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Figure 7. Typical Gate Trigger Current Vs. Junction Temperature

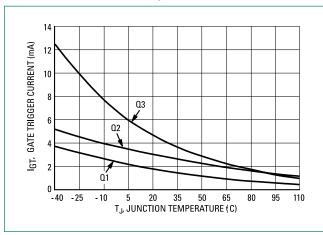


Figure 9. Typical Exponential Static dv/dt Vs. Gate-MT1 Resistance, MT2(+)

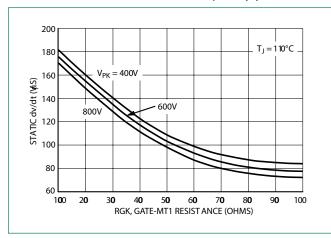


Figure 11. Typical Exponential Static dv/dt Vs. Junction Temperature, MT2(+)

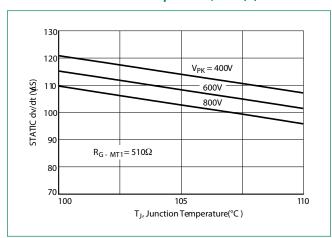


Figure 8. Typical Gate Trigger Voltage Vs. Junction Temperature

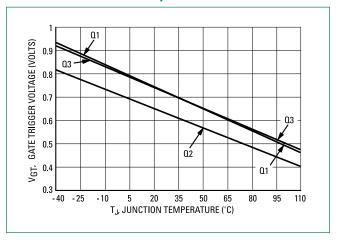


Figure 10. Typical Exponential Static dv/dt Versus Peak Voltage, MT2(+)

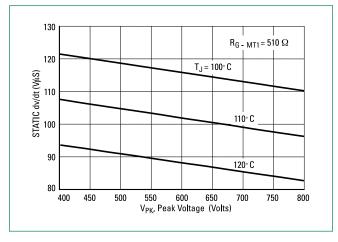
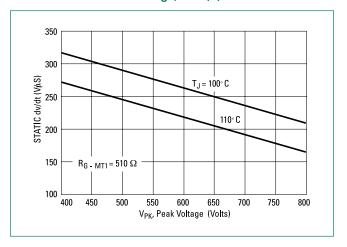


Figure 12. Typical Exponential Static dv/dt Vs. Peak Voltage, MT2(-)





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Figure 13. Typical Exponential Static dv/dt Versus Junction Temperature, MT2(-)

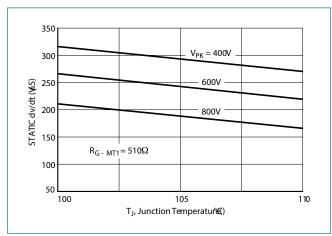


Figure 14. Typical Exponential Static dv/dt Versus Gate-MT1 Resistance, MT2(-)

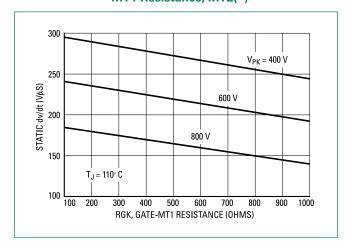


Figure 15. Critical Rate of Rise of Commutating Voltage

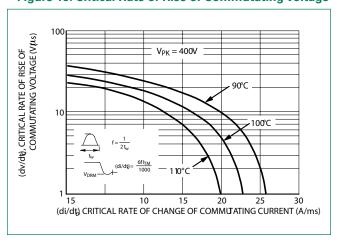
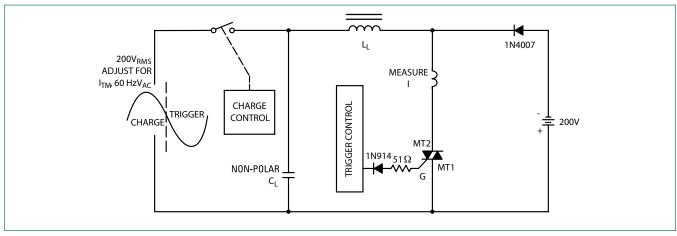


Figure 16. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)

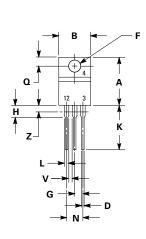


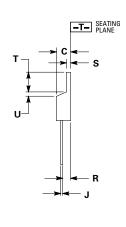
Note: Component values are for verification of rated (di/dt)c. See AN1048 for additional information



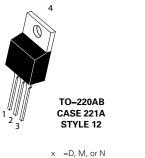
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Dimensions



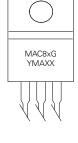


Part Marking System





A =Assembly Site XX =Lot Serial Code G =Pb-Free Package



D:	Inches Dim		Millimeters		
DIM	Min	Max	Min	Max	
Α	0.590	0.620	14.99	15.75	
В	0.380	0.420	9.65	10.67	
С	0.178	0.188	4.52	4.78	
D	0.025	0.035	0.64	0.89	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.41	2.67	
Н	0.110	0.130	2.79	3.30	
J	0.018	0.024	0.46	0.61	
K	0.540	0.575	13.72	14.61	
L	0.060	0.075	1.52	1.91	
N	0.195	0.205	4.95	5.21	
Q	0.105	0.115	2.67	2.92	
R	0.085	0.095	2.16	2.41	
S	0.045	0.060	1.14	1.52	
T	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
V	0.045		1.15		
Z		0.080		2.04	

_		0.0
Dimensioning and Controlling dimens	tolerancing per ansi y14.5m,	1982.

^{3.} Dimension z defines a zone where all body and lead irregularities are allowed.

Pin Assignment			
1	Main Terminal 1		
2	Main Terminal 2		
3	Gate		
4	No Connection		

Ordering Information

Device	Package	Shipping
MAC8SDG	TO-220AB (Pb-Free)	
MAC8SMG		1000 Units / Box
MAC8SNG	(I D I I CC)	

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